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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



**HIGH SENSITIVITY MICROPOWER
OMNIPOLAR HALL-EFFECT SWITCH**

NEW PRODUCT

Description

The AH1893 is a high sensitivity micropower Omnipolar Hall effect switch IC with internal pull up and pull down capability. Designed for portable and battery powered equipment such as cellular phones and portable PCs to home appliances and industrial applications, the average supply current is only 4.3µA at 1.85V. To support portable equipment the AH1893 can operate over the supply range of 1.6V to 3.6V and uses a hibernating clocking system to minimize the power consumption. To minimize PCB space the AH1893 is available in small low profile X1-DFN1216-4 and SOT553 packages.

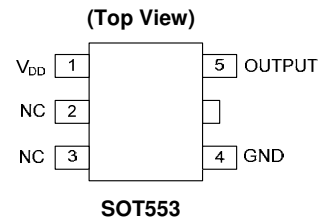
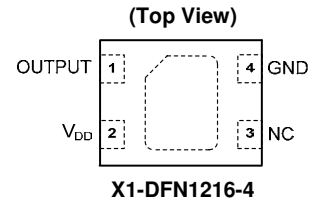
The output is activated with either a north or south pole of sufficient magnetic field strength. When the magnetic flux density (**B**) perpendicular to the package is larger than operate point (**Bop**), the output will be turned on (pulled low) and held until **B** is lower than release point (**Brp**).

Features

- Omnipolar Operation (North or South pole)
- Supply Voltage of 1.6V to 3.6V
- High Sensitivity
- Micropower Operation
- Chopper Stabilized Design Provides
 - Superior Temperature Stability
 - Minimal Switch Point Drift
 - Enhanced Immunity to Physical Stress
- No External Pull-up Resistors Required
- Good RF Noise Immunity
- -40°C to +85°C Operating Temperature
- High ESD capability of 8kV (Human Body Model)
- Small Low Profile SOT553 and X1-DFN1216-4 Packages
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

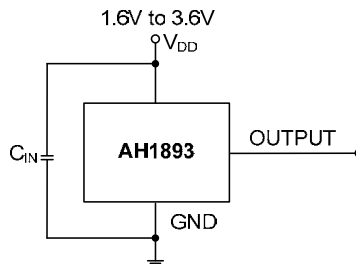
Pin Assignments



Applications

- Open and Close Detect for Cellular Phones
- Holster or Cover Detect for Cellular Phones and Tablet PCs
- Cover or Display Switch in Portable PCs
- Digital Still, Video Cameras and Handheld Gaming Consoles
- Door, Lids and Tray Position Switches
- Level, Proximity and Position Switches
- Contact-Less Switches in Home Appliances and Industrial Applications

Typical Applications Circuit



Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 100nF typical.

Pin Descriptions

Package: X1-DFN1216-4

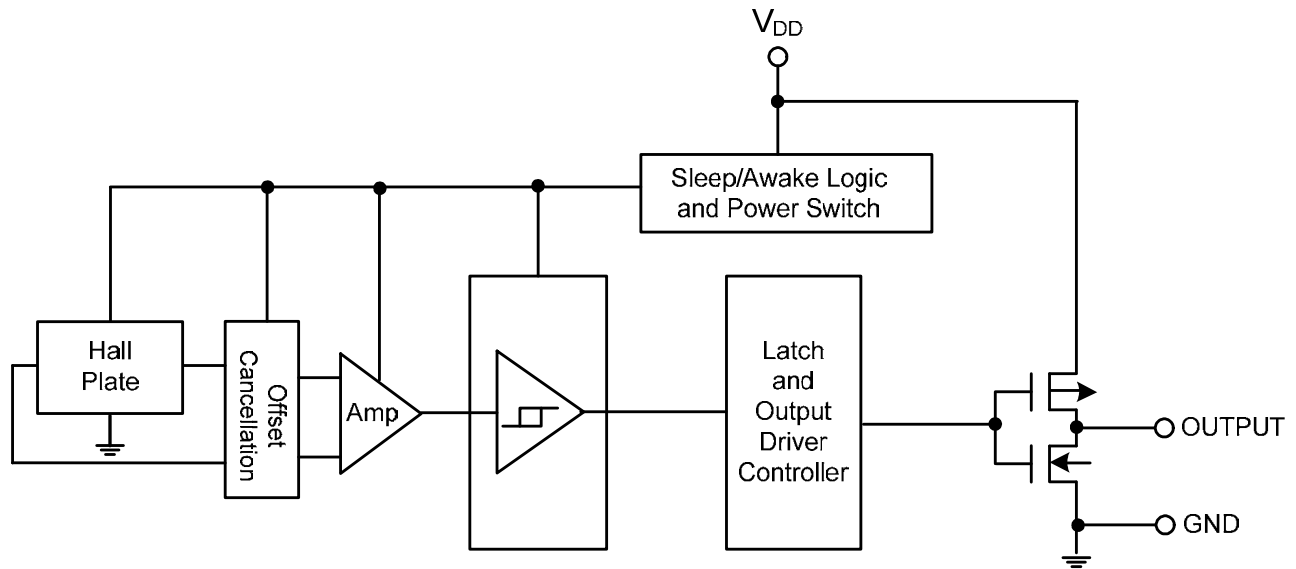
Pin Number	Pin Name	Function
1	OUTPUT	Output Pin
2	V _{DD}	Power Supply Input
3	NC	No Connection (Note 5)
4	GND	Ground Pin

Package: SOT553

Pin Number	Pin Name	Function
1	V _{DD}	Power Supply Input
2	NC	No Connection (Note 5)
3	NC	No Connection (Note 5)
4	GND	Ground
5	OUTPUT	Output

Note: 5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

Functional Block Diagram



Absolute Maximum Ratings (Note 6) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Rating	Unit	
V_{DD}	Supply Voltage (Note 7)	6	V	
V_{DD_REV}	Reverse Supply Voltage	-0.3	V	
I_{OUTPUT}	Output current (source and sink)	3	mA	
B	Magnetic Flux Density	Unlimited		
P_D	Package Power Dissipation	X1-DFN1216-4	230	mW
		SOT553	230	mW
T_s	Storage Temperature Range	-65 to +150	$^\circ\text{C}$	
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$	
ESD HBM	Human Body Model (HBM) ESD capability	8	kV	

- Notes:
- Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
 - The absolute maximum V_{DD} of 6V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

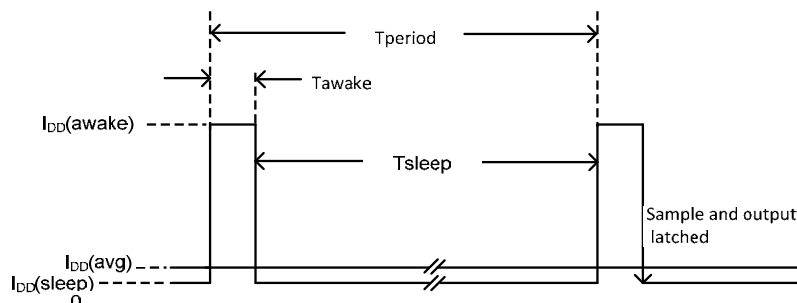
Recommended Operating Conditions (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	1.6V to 3.6V	V
T_A	Operating Temperature Range	Operating	-40 to +85	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, $V_{DD} = 1.85\text{V}$, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OL}	Output Low Voltage (on)	$I_{OUT} = 1\text{mA}$	-	0.1	0.2	V
V_{OH}	Output High Voltage (off)	$I_{OUT} = -1\text{mA}$	$V_{DD}-0.2$	$V_{DD}-0.1$	—	V
I_{off}	Output Leakage Current	$V_{OUT} = 3.6\text{V}$, Output IOff	—	< 0.1	1	μA
$I_{DD}(\text{awake})$	Supply Current	During 'Awake' Period, $T_A = +25^\circ\text{C}$, $V_{DD} = 3\text{V}$	—	2.1	—	mA
$I_{DD}(\text{sleep})$		During 'Sleep' Period, $T_A = +25^\circ\text{C}$, $V_{DD} = 3\text{V}$	—	2.5	—	mA
$I_{DD}(\text{avg})$	Average Supply Current	$T_A = +25^\circ\text{C}$, $V_{DD} = 1.85\text{V}$	—	4.3	8	μA
		$T_A = +25^\circ\text{C}$, $V_{DD} = 3.6\text{V}$	—	7.2	13	μA
T_{awake}	Awake Time	(Note 8)	—	50	100	μs
T_{period}	Period	(Note 8)	—	50	100	ms
D.C.	Duty Cycle		—	0.1	—	%

- Note: 8. When power is initially turned on, the operating V_{DD} (1.6V to 3.6V) must be applied to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 100ms).

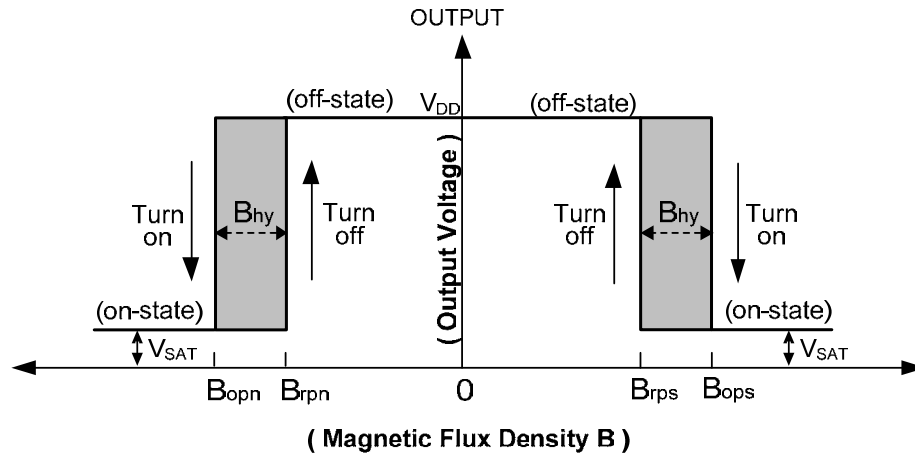


Magnetic Characteristics (Note 9 & 10) ($T_A = +25^\circ\text{C}$, $V_{DD} = 1.85\text{V}$, unless otherwise specified)

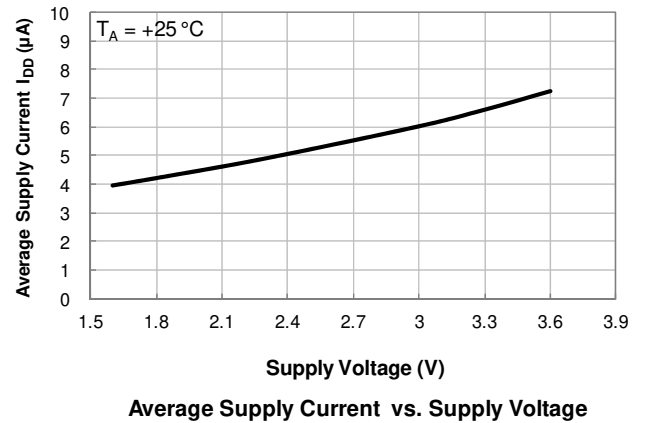
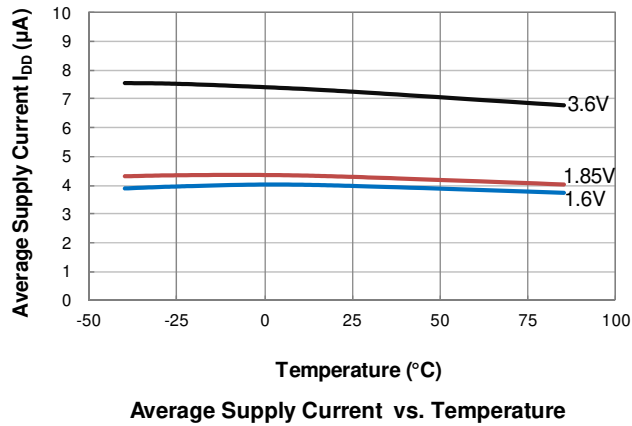
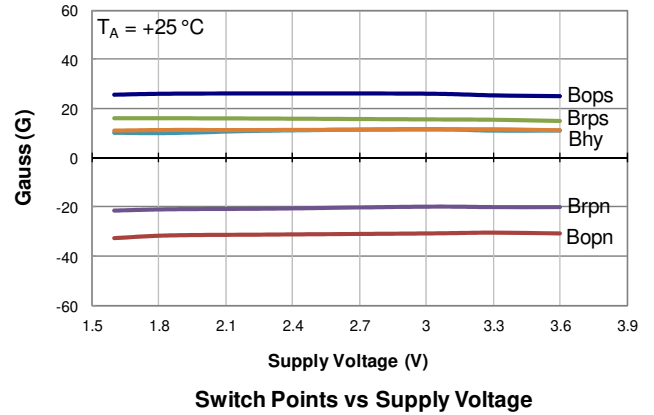
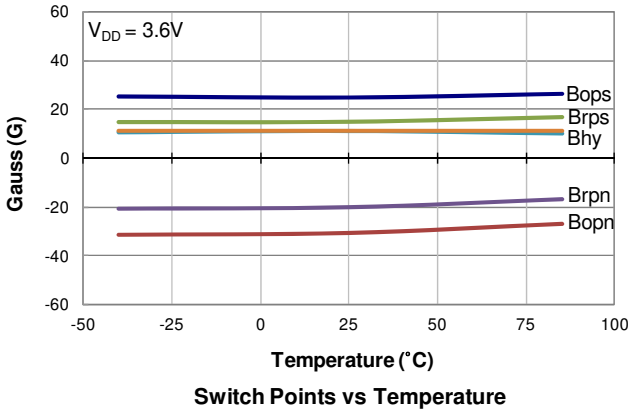
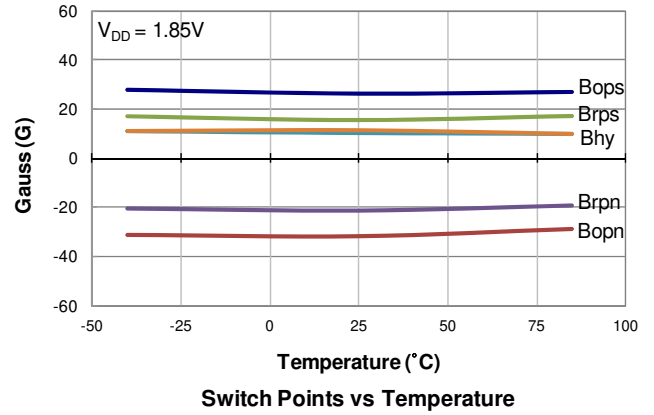
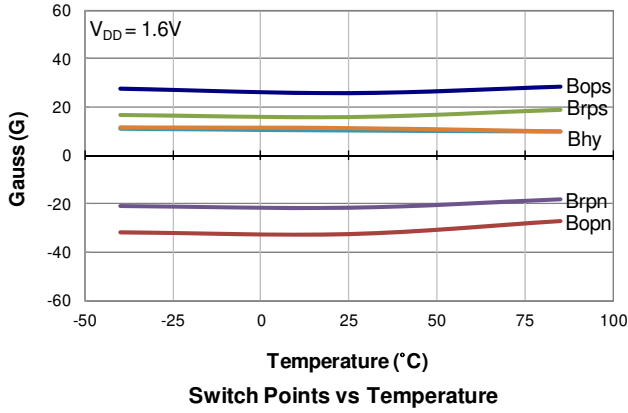
(1mT=10 Gauss)

Symbol	Characteristics	Test Condition	Min	Typ	Max	Unit
Bops (south pole to part marking side)	Operation Point	$T_A = +25^\circ\text{C}$	16	30	42	Gauss
Bopn (north pole to part marking side)		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$	14	30	46	
Brps (south pole to part marking side)		$T_A = +25^\circ\text{C}$	-42	-30	-16	
Brpn (north pole to part marking side)		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$	-46	-30	-14	
Bhy (Bopx - Brpx)	Hysteresis (Note 11)	$T_A = +25^\circ\text{C}$	5	10	15	
		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$	-	10	-	
		$T_A = +25^\circ\text{C}$	10	20	35	
		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$	9	20	39	
Bops (south pole to part marking side)	Release Point	$T_A = +25^\circ\text{C}$	-35	-20	-10	
		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$	-39	-20	-9	
		$T_A = +25^\circ\text{C}$	5	10	15	
		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$	-	10	-	

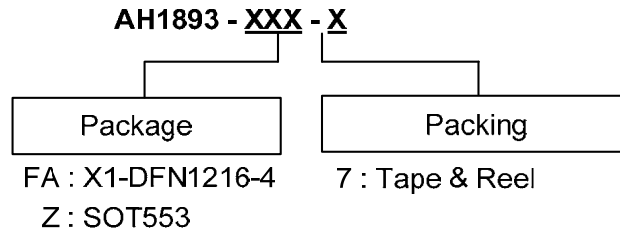
- Notes:
9. Typical data is at $T_A = +25^\circ\text{C}$, $V_{DD} = 1.85\text{V}$.
 10. Maximum and minimum parameters values over the operating temperature range are not tested in production, they are guaranteed by design, process control and characterization. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.
 11. Maximum and minimum hysteresis is guaranteed by design and characterization.



Typical Operating Characteristics



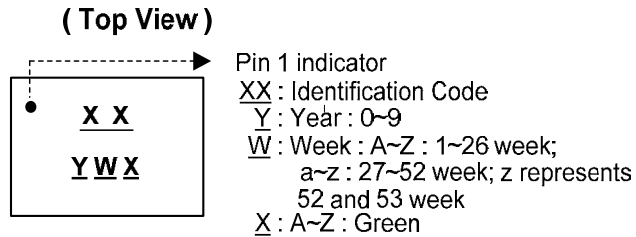
Ordering Information



Part Number	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
AH1893-FA-7	FA	X1-DFN1216-4	3000/Tape & Reel	-7
AH1893-Z-7	Z	SOT553	3000/Tape & Reel	-7

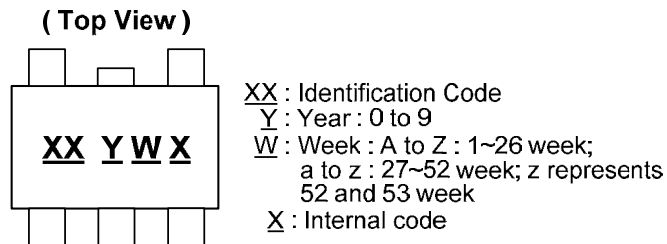
Marking Information

(1) Package Type: X1-DFN1216-4



Part Number	Package	Identification Code
AH1893-FA-7	X1-DFN1216-4	B3

(2) Package Type: SOT553

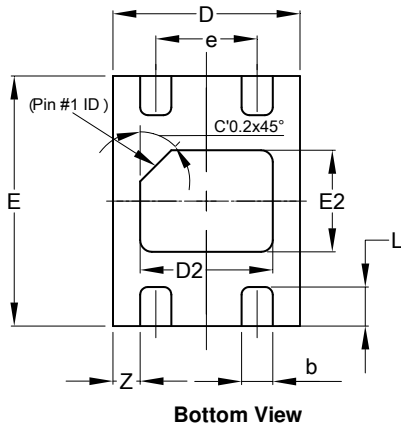
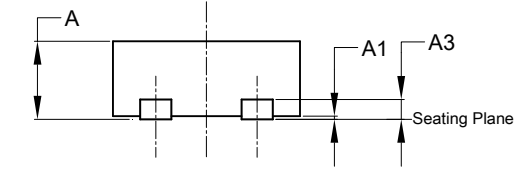


Part Number	Package	Identification Code
AH1893-Z-7	SOT553	B3

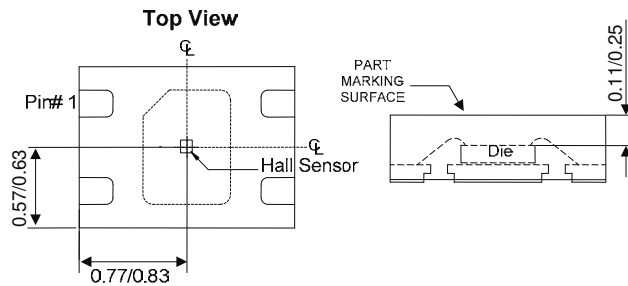
Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

(1) Package Type: X1-DFN1216-4



X1-DFN1216-4			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0.00	0.05	0.02
A3	--	--	0.13
b	0.15	0.25	0.20
D	1.15	1.25	1.20
D2	0.75	0.95	0.85
E	1.55	1.65	1.60
E2	0.55	0.75	0.65
e	-	-	0.65
L	0.20	0.30	0.25
Z	-	-	0.175
All Dimensions in mm			

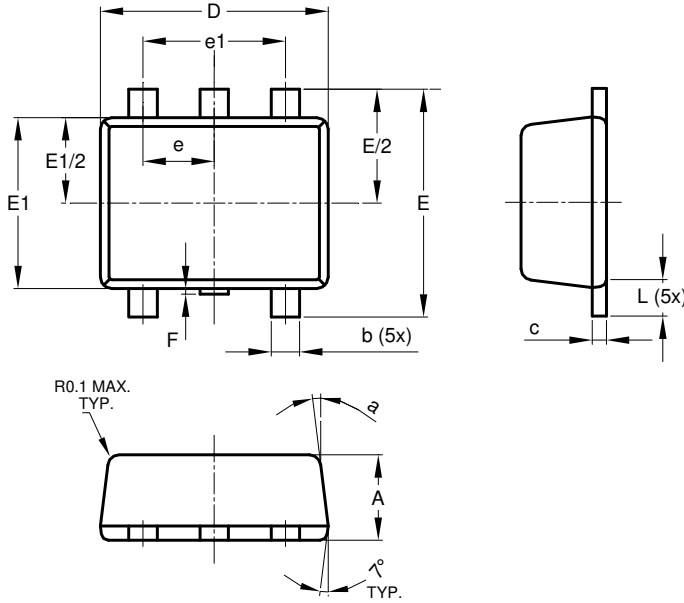


Sensor Location

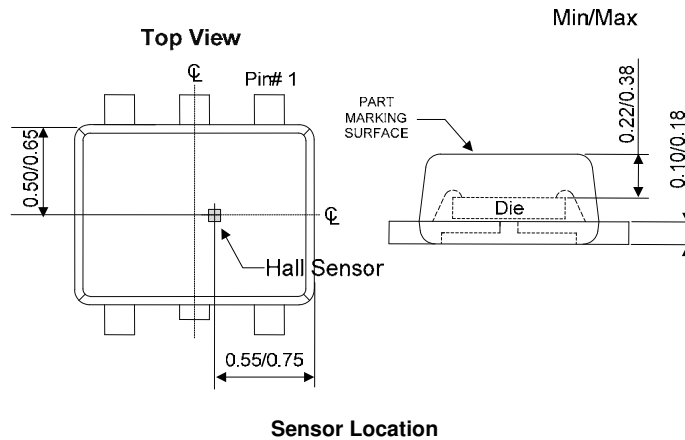
NEW PRODUCT

Package Outline Dimensions (cont.) (All dimensions in mm.)

(2) Package Type: SOT553



SOT553			
Dim	Min	Max	Typ
A	0.55	0.62	0.60
b	0.15	0.30	0.20
c	0.10	0.18	0.15
D	1.50	1.70	1.60
E	1.55	1.70	1.60
E1	1.10	1.25	1.20
e	0.50 BSC		
e1	1.00 BSC		
F	0.00	0.10	—
L	0.10	0.30	0.20
a	6°	8°	7°
All Dimensions in mm			

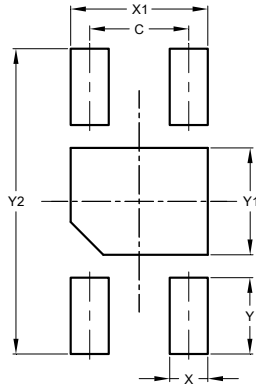


NEW PRODUCT

Suggested Pad Layout

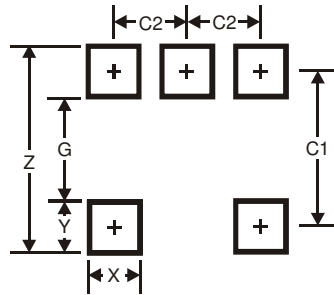
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

(1) Package Type: X1-DFN1216-4



X1-DFN1216-4	
Dimensions	Value
C	0.65
X	0.25
X1	0.90
Y	0.50
Y1	0.70
Y2	2.00
All Dimensions in mm	

(2) Package Type: SOT553



SOT553	
Dimensions	Value
Z	2.2
G	1.2
X	0.375
Y	0.5
C1	1.7
C2	0.5
All Dimensions in mm	

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